MOSFET – Power, Single, N-Channel, SO-8FL 25 V, 334 A

Features

- Optimized Design to Minimize Conduction and Switching Losses
- Optimized Package to Minimize Parasitic Inductances
- Optimized material for improved thermal performance
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- High Performance DC-DC Converters
- System Voltage Rails
- Netcom, Telecom
- Servers & Point of Load

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Parameter	Symbol	Value	Units			
Drain-to-Source Voltage	V _{DSS}	25	V			
Gate-to-Source Voltage	V _{GS}	±20	V			
Continuous Drain Current $R_{\theta JA}$ (T _A = 25°C, Note 1)	۱ _D	54	A			
Power Dissipation $R_{\theta JA}$ (T _A = 25°C, Note 1)	P _D	3.2	W			
Continuous Drain Current $R_{\theta JC}$ (T _C = 25°C, Note 1)	۱ _D	334	A			
Power Dissipation $R_{\theta JC}$ (T _C = 25°C, Note 1)	P _D	125	W			
Pulsed Drain Current ($t_p = 10 \ \mu s$)	I _{DM}	568	А			
Single Pulse Drain-to-Source Avalanche Energy (Note 1) (I _L = 58 A _{pk} , L = 0.3 mH)	E _{AS}	505	mJ			
Drain to Source dV/dt	dV/dt	7	V/ns			
Maximum Junction Temperature	T _{J(max)}	150	°C			
Storage Temperature Range	T _{STG}	–55 to 150	°C			
Lead Temperature Soldering Reflow (SMD Styles Only), Pb-Free Versions (Note 2)	T _{SLD}	260	°C			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 Values based on copper area of 645 mm² (or 1 in²) of 2 oz copper thickness and FR4 PCB substrate.

- For more information, please refer to our Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.
- 3. This is the absolute maximum rating. Parts are 100% UIS tested at T_J = 25°C, V_{GS} = 10 V, I_L = 38 A, E_{AS} = 217 mJ.



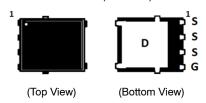
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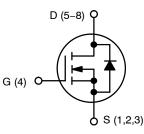
V _{GS}	MAX R _{DS(on)}	TYP Q _{GTOT}
4.5 V	$0.97~\mathrm{m}\Omega$	39 nC
10 V	$0.7~\mathrm{m}\Omega$	85 nC

PIN CONNECTIONS

SO8-FL (5 x 6 mm)



N-CHANNEL MOSFET



ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

THERMALCHARACTERISTICS

Parameter	Symbol	Max	Units
Thermal Resistance, Junction-to-Ambient (Note 1 and 4) Junction-to-Case (Note 1 and 4)	${f R}_{ heta JA} \ {f R}_{ heta JC}$	38.9 1.0	°C/W

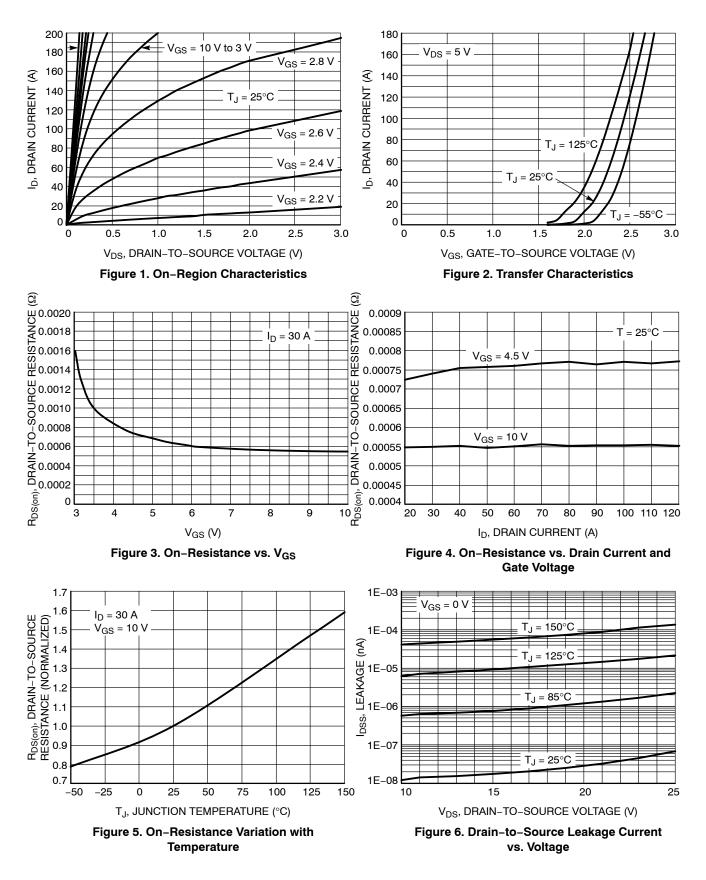
4. Thermal Resistance $R_{\theta JA}$ and $R_{\theta JC}$ as defined in JESD51–3.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

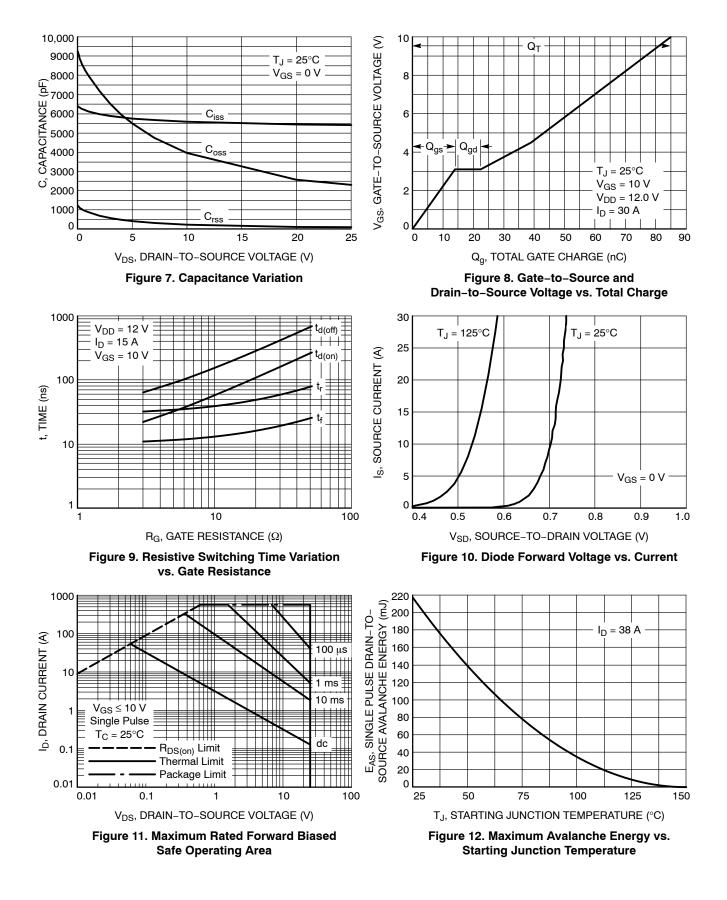
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		25			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				13		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$			1	
		V _{DS} = 20 V	T _J = 125°C			30	μA
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS}	= +20 V			+100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μA	1.2		2.1	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A		0.55	0.7	
		V _{GS} = 4.5 V	I _D = 30 A		0.76	0.97	mΩ
Forward Transconductance	9 FS	V _{DS} = 12 V, I _E	₀ = 15 A		101		S
CHARGES, CAPACITANCES & GATE RESIS	STANCE						
Input Capacitance	C _{ISS}				5693		
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MH	z, V _{DS} = 12 V		3718		pF
Reverse Transfer Capacitance	C _{RSS}	1			212		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 12 V; I _D = 30 A			39		
Threshold Gate Charge	Q _{G(TH)}				2.4		nC
Gate-to-Source Charge	Q _{GS}				14		
Gate-to-Drain Charge	Q _{GD}				8.5		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 12 V; I_{D} = 30 A			85		nC
Gate Resistance	R _G	$T_A = 25^{\circ}C$			1.2	2	Ω
SWITCHING CHARACTERISTICS, $V_{GS} = 4.5$	V (Note 5)						
Turn-On Delay Time	t _{d(ON)}				18		
Rise Time	t _r	V _{GS} = 4.5 V, V _{DS} = 1	2 V, I _D = 15 A,		49		- ns
Turn-Off Delay Time	t _{d(OFF)}	R _G = 3.0	Ω		46		
Fall Time	t _f				35		
SWITCHING CHARACTERISTICS, $V_{GS} = 10$	V (Note 5)						
Turn-On Delay Time	t _{d(ON)}				11		
Rise Time	t _r	V _{GS} = 11.5 V, V _I	_{DS} = 12 V,		33.6		
Turn-Off Delay Time	t _{d(OFF)}	$I_{\rm D} = 15$ A, $R_{\rm G} = 3.0 \ \Omega$			46		- ns
Fall Time	t _f				34		
DRAIN-SOURCE DIODE CHARACTERISTIC	S				-		
Forward Diode Voltage	V _{SD}	VGS = 0 V,	$T_J = 25^{\circ}C$		0.75	1.1	
			T _J = 125°C		0.55		V
Reverse Recovery Time	t _{RR}		•		68.7		
Charge Time	ta	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 30 A			34.1		ns
Discharge Time	t _b				34.6		1
Reverse Recovery Charge	Q _{RR}				90		nC

performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 6. Switching characteristics are independent of operating junction temperatures.

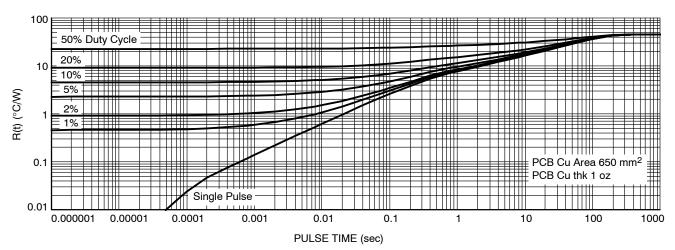
TYPICAL CHARACTERISTICS



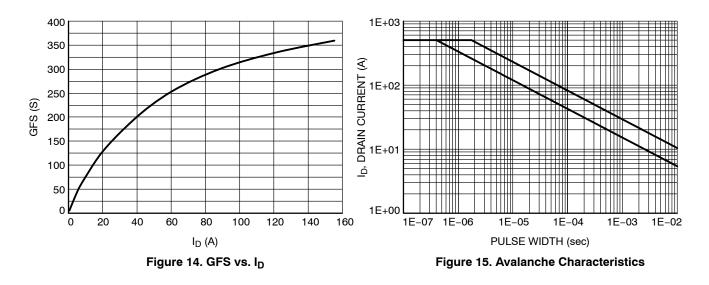
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



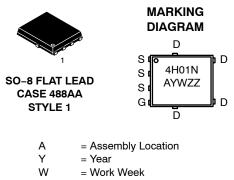




ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4H01NT1G	SO8–FL (Pb-Free)	1500 / Tape & Reel
NTMFS4H01NT3G	SO8-FL (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



ZZ = Lot Traceability





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